

/ Descriptions

TO-220

Schottky Barrier Diode in a TO-220 Plastic Package.

/ Features

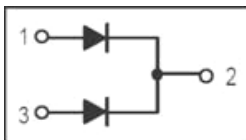
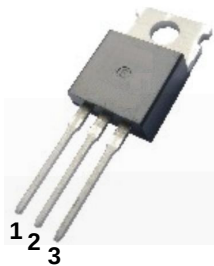
Low forward voltage drop low power losses High efficiency operation.

/ Applications

OR-ing

DC-DC

For use in high frequency inverters, switching power supplies, freewheeling diodes,
OR-ing diode, dc-to-dc converters and reverse battery protection.

/ Equivalent Circuit**/ Pinning**

PIN1 Anode PIN 2 Cathode PIN 3 Anode

/ h_{FE} Classifications & Marking

See Marking Instructions.

/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RM} V_{RSM} V_{DC}	150	V
RMS Reverse Voltage	V_{RMS}	105	V
Average Rectified Forward Current	$I_{F(AV)}$	2×20	A
Non Repetitive Peak Surge Current	I_{FSM}	300	A
Thermal Resistance Junction to Case	$R_{\theta Jc}$	2.8	/W
Junction and Storage Temperature Range	T_j, T_{stg}	-40 +150	

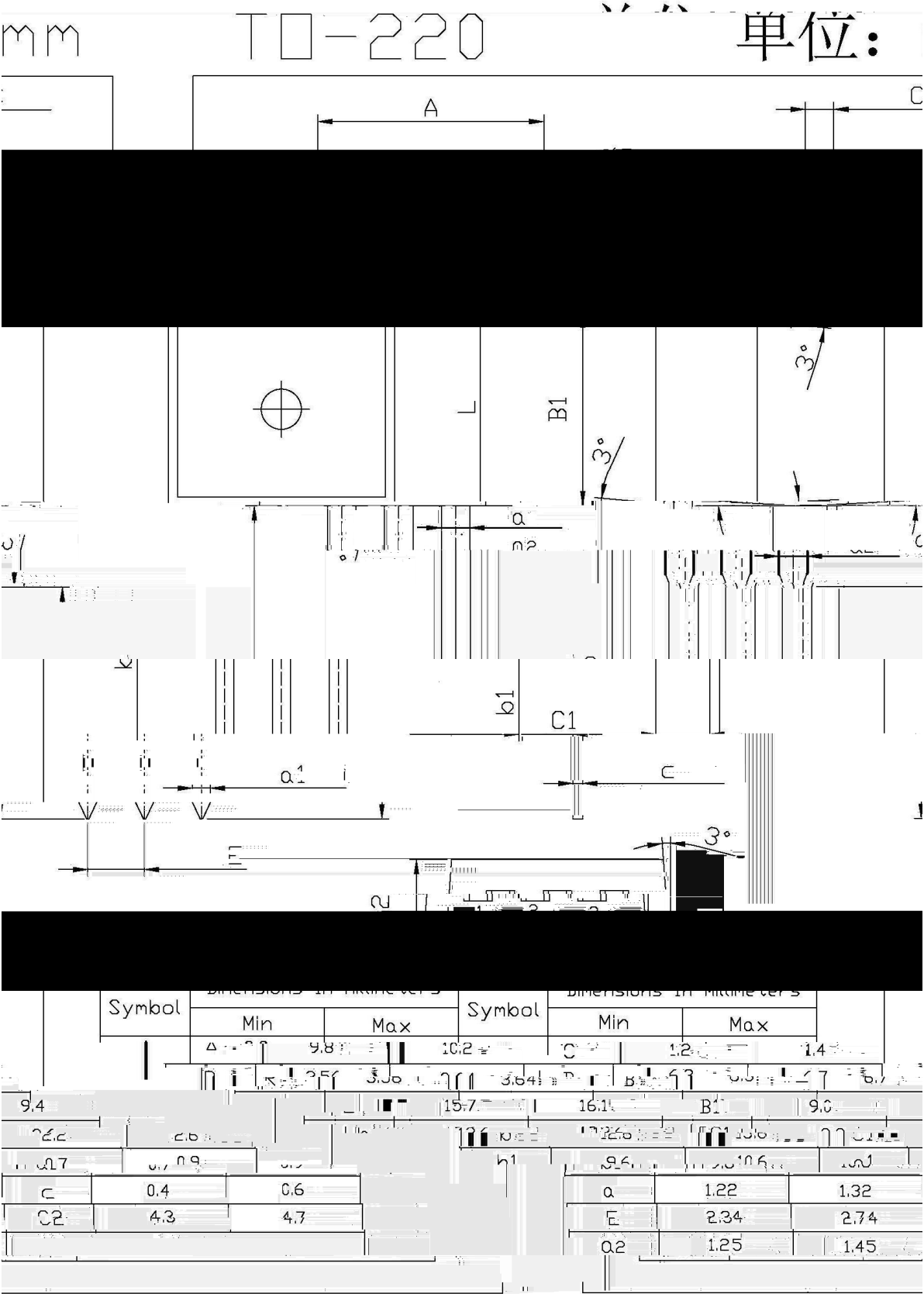
/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Reverse Voltage	V_{BR}	$I_R=1mA(Ta=25)$	150			V
Forward Voltage	V_F	$I_F=5A(Ta=25)$		0.68		V
		$I_F=10A(Ta=25)$		0.76		V
		$I_F=20A(Ta=25)$		0.89	1.05	V
		$I_F=5A(Ta=125)$		0.56		V
		$I_F=10A(Ta=125)$		0.63		V
		$I_F=20A(Ta=125)$		0.73	0.85	V
Instantaneous Reverse Current	I_R Note 1	$V_{BR}=150V(Ta=25)$		3.0	30	uA
		$V_{BR}=150V(Ta=125)$		5.0	15	mA

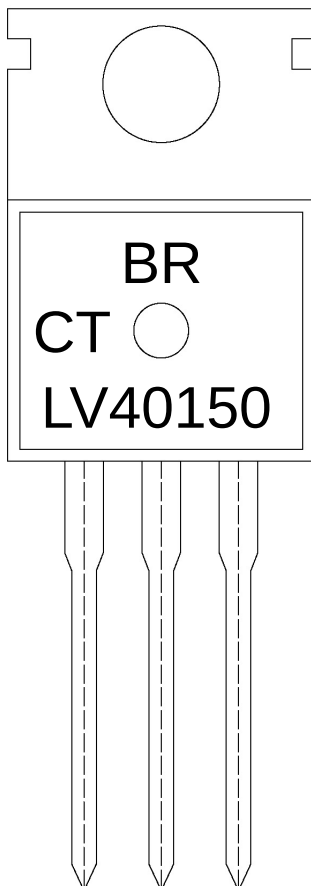
/Notes

1. /Short duration pulse test used to minimize self-heating effect.
2. / Unless otherwise noted, values for the parameters of a single chip

/ Package Dimensions



/ Marking Instructions



BR

LV40150

CT:

Note:

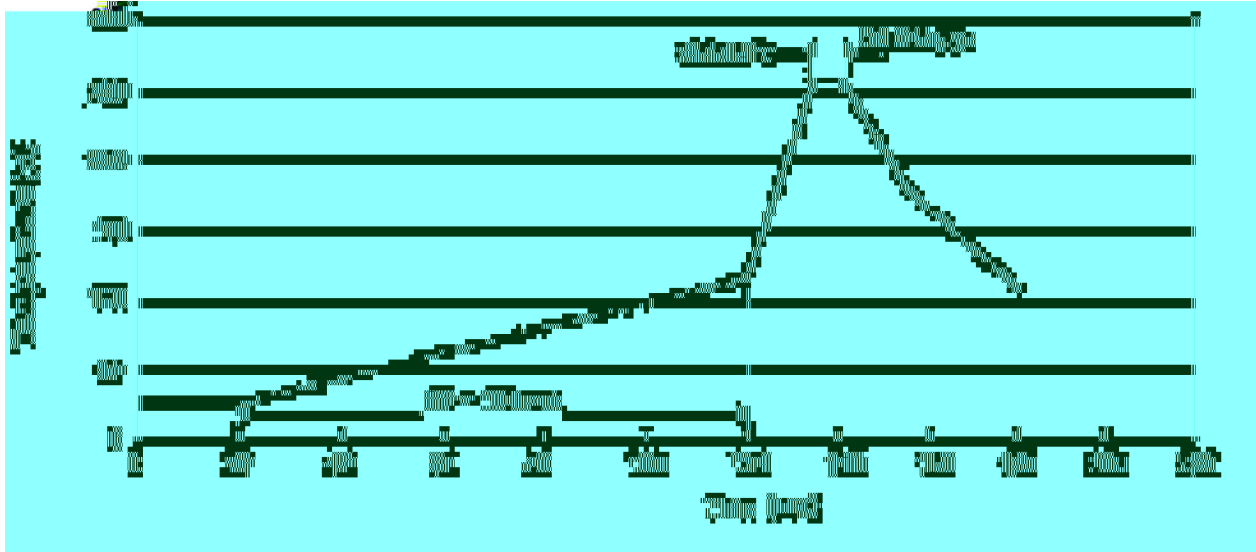
BR: Company Code

LV40150 Product Type.

CT: Internal Structure

****: Lot No. Code, code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-------|-----|-----------|---|--------------------------------------|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 255±5 | | 5±0.5sec; | 2.Peak Temp.:255±5 , Duration:5±0.5sec. | |
| 3 | | 2 | 10 | /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

270±5 10±1 sec. Temp.:270±5 Time:10±1 sec

/ Packaging SPEC.

/ BULK

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	只袋	袋盒	只盒	盒箱	只箱	袋	盒	箱

/ TUBE

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	只套管	套管盒	只盒	盒箱	只箱	套管	盒	箱

/ Notices